

DATA SHEET



BGD804

**860 MHz, 20 dB gain power
doubler amplifier**

Product specification
Supersedes data of 1999 Mar 26

2001 Nov 01

860 MHz, 20 dB gain power doubler amplifier

BGD804

FEATURES

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability.

APPLICATIONS

CATV systems in the 40 to 860 MHz frequency range.

DESCRIPTION

Hybrid amplifier module in a SOT115J package operating at a voltage supply of 24 V (DC).

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G_p	power gain	$f = 50 \text{ MHz}$	19.5	20.5	dB
		$f = 860 \text{ MHz}$	20	–	dB
I_{tot}	total current consumption (DC)	$V_B = 24 \text{ V}$	–	410	mA

LIMITING VALUES

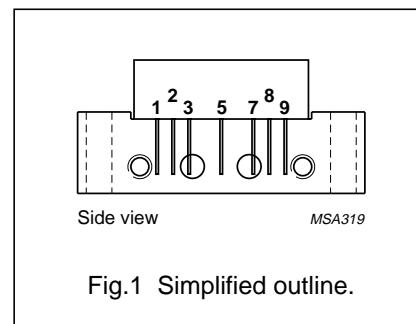
In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_i	RF input voltage	–	65	dBmV
T_{stg}	storage temperature	–40	+100	°C
T_{mb}	operating mounting base temperature	–20	+100	°C
V_B	supply voltage	–	25	V

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2	common
3	common
5	+ V_B
7	common
8	common
9	output

PIN CONFIGURATION



860 MHz, 20 dB gain power doubler amplifier

BGD804

CHARACTERISTICS

Table 1 Bandwidth 40 to 860 MHz; $V_B = 24$ V; $T_{case} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G _p	power gain	f = 50 MHz	19.5	20	20.5	dB
		f = 860 MHz	20	21	–	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.2	1.1	2	dB
FL	flatness of frequency response	f = 40 to 860 MHz	–	±0.2	±0.5	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	28	–	dB
		f = 80 to 160 MHz	18.5	23	–	dB
		f = 160 to 320 MHz	17	20	–	dB
		f = 320 to 640 MHz	15.5	20	–	dB
		f = 640 to 860 MHz	14	20	–	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	28.5	–	dB
		f = 80 to 160 MHz	18.5	28	–	dB
		f = 160 to 320 MHz	17	24	–	dB
		f = 320 to 640 MHz	15.5	19	–	dB
		f = 640 to 860 MHz	14	19	–	dB
S ₂₁	phase response	f = 50 MHz	–45	–	+45	deg
CTB	composite triple beat	49 channels flat; V _o = 47 dBmV; measured at 859.25 MHz	–	–64	–61	dB
X _{mod}	cross modulation	49 channels flat; V _o = 47 dBmV; measured at 55.25 MHz	–	–65.5	–62	dB
CSO	composite second order distortion	49 channels flat; V _o = 47 dBmV; measured at 860.5 MHz	–	–63	–58	dB
d ₂	second order distortion	note 1	–	–73	–67	dB
V _o	output voltage	d _{im} = –60 dB; note 2	+60	–61.5	–	dBmV
F	noise figure	f = 50 MHz	–	4.5	5	dB
		f = 550 MHz	–	–	6	dB
		f = 650 MHz	–	–	6	dB
		f = 750 MHz	–	–	6.5	dB
		f = 860 MHz	–	6.5	7.5	dB
I _{tot}	total current consumption (DC)	note 3	–	395	410	mA

Notes

- f_p = 55.25 MHz; V_p = 44 dBmV;
f_q = 805.25 MHz; V_q = 44 dBmV;
measured at f_p + f_q = 860.5 MHz.
- Measured according to DIN45004B;
f_p = 851.25 MHz; V_p = V_o;
f_q = 858.25 MHz; V_q = V_o –6 dB;
f_r = 860.25 MHz; V_r = V_o –6 dB;
measured at f_p + f_q – f_r = 849.25 MHz.
- The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

860 MHz, 20 dB gain power doubler amplifier

BGD804

Table 2 Bandwidth 40 to 860 MHz; $V_B = 24$ V; $T_{case} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G _p	power gain	f = 50 MHz	19.5	20	20.5	dB
		f = 860 MHz	20	21	–	dB
SL	slope cable equivalent	f = 40 to 860 MHz	0.2	1.1	2	dB
FL	flatness of frequency response	f = 40 to 860 MHz	–	±0.2	±0.5	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	28	–	dB
		f = 80 to 160 MHz	18.5	23	–	dB
		f = 160 to 320 MHz	17	20	–	dB
		f = 320 to 640 MHz	15.5	20	–	dB
		f = 640 to 860 MHz	14	20	–	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	28.5	–	dB
		f = 80 to 160 MHz	18.5	28	–	dB
		f = 160 to 320 MHz	17	24	–	dB
		f = 320 to 640 MHz	15.5	19	–	dB
		f = 640 to 860 MHz	14	19	–	dB
S ₂₁	phase response	f = 50 MHz	–45	–	+45	deg
CTB	composite triple beat	129 channels flat; V _o = 44 dBmV; measured at 859.25 MHz	–	–54	–53	dB
X _{mod}	cross modulation	129 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	–	–62	–61	dB
CSO	composite second order distortion	129 channels flat; V _o = 44 dBmV; measured at 860.5 MHz	–	–60.5	–54	dB
d ₂	second order distortion	note 1	–	–73	–67	dB
V _o	output voltage	d _{im} = –60 dB; note 2	+60	–61.5	–	dBmV
F	noise figure	see Table 1	–	–	–	dB
I _{tot}	total current consumption (DC)	note 3	–	395	410	mA

Notes

1. $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 805.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 860.5$ MHz.
2. Measured according to DIN45004B;
 $f_p = 851.25$ MHz; $V_p = V_o$;
 $f_q = 858.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 860.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 849.25$ MHz.
3. The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

860 MHz, 20 dB gain power doubler amplifier

BGD804

Table 3 Bandwidth 40 to 750 MHz; $V_B = 24$ V; $T_{case} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G _p	power gain	f = 50 MHz	19.5	20	20.5	dB
		f = 750 MHz	20	20.8	–	dB
SL	slope cable equivalent	f = 40 to 750 MHz	0.2	–	2	dB
FL	flatness of frequency response	f = 40 to 750 MHz	–	–	±0.45	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	28	–	dB
		f = 80 to 160 MHz	18.5	23	–	dB
		f = 160 to 320 MHz	17	20	–	dB
		f = 320 to 640 MHz	15.5	20	–	dB
		f = 640 to 750 MHz	14	20	–	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	28.5	–	dB
		f = 80 to 160 MHz	18.5	28	–	dB
		f = 160 to 320 MHz	17	24	–	dB
		f = 320 to 640 MHz	15.5	19	–	dB
		f = 640 to 750 MHz	14	19	–	dB
S ₂₁	phase response	f = 50 MHz	–45	–	+45	deg
CTB	composite triple beat	110 channels flat; V _o = 44 dBmV; measured at 745.25 MHz	–	–59	–57	dB
X _{mod}	cross modulation	110 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	–	–64	–62	dB
CSO	composite second order distortion	110 channels flat; V _o = 44 dBmV; measured at 746.5 MHz	–	–62	–56	dB
d ₂	second order distortion	note 1	–	–	–68	dB
V _o	output voltage	d _{im} = –60 dB; note 2	63	–	–	dBmV
F	noise figure	see Table 1	–	–	–	dB
I _{tot}	total current consumption (DC)	note 3	–	395	410	mA

Notes

1. $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 691.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 746.5$ MHz.
2. Measured according to DIN45004B;
 $f_p = 740.25$ MHz; $V_p = V_o$;
 $f_q = 747.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 749.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 738.25$ MHz.
3. The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

860 MHz, 20 dB gain power doubler amplifier

BGD804

Table 4 Bandwidth 40 to 650 MHz; $V_B = 24$ V; $T_{case} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G _p	power gain	f = 50 MHz	19.5	20	20.5	dB
		f = 650 MHz	20	20.7	–	dB
SL	slope cable equivalent	f = 40 to 650 MHz	0.2	–	2	dB
FL	flatness of frequency response	f = 40 to 650 MHz	–	–	±0.35	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	28	–	dB
		f = 80 to 160 MHz	18.5	23	–	dB
		f = 160 to 320 MHz	17	20	–	dB
		f = 320 to 650 MHz	15	20	–	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	28.5	–	dB
		f = 80 to 160 MHz	18.5	28	–	dB
		f = 160 to 320 MHz	17	24	–	dB
		f = 320 to 650 MHz	15	19	–	dB
S ₂₁	phase response	f = 50 MHz	–45	–	+45	deg
CTB	composite triple beat	94 channels flat; V _o = 44 dBmV; measured at 649.25 MHz	–	–	–60	dB
X _{mod}	cross modulation	94 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	–	–	–62	dB
CSO	composite second order distortion	94 channels flat; V _o = 44 dBmV; measured at 650.5 MHz	–	–	–58	dB
d ₂	second order distortion	note 1	–	–	–69	dB
V _o	output voltage	d _{im} = –60 dB; note 2	65	–	–	dBmV
F	noise figure	see Table 1	–	–	–	dB
I _{tot}	total current consumption (DC)	note 3	–	395	410	mA

Notes

1. $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 595.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 650.5$ MHz.
2. Measured according to DIN45004B;
 $f_p = 640.25$ MHz; $V_p = V_o$;
 $f_q = 647.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 649.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 638.25$ MHz.
3. The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

860 MHz, 20 dB gain power doubler amplifier

BGD804

Table 5 Bandwidth 40 to 550 MHz; $V_B = 24$ V; $T_{case} = 35$ °C; $Z_S = Z_L = 75$ Ω

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G _p	power gain	f = 50 MHz	19.5	20	20.5	dB
		f = 550 MHz	20	20.6	–	dB
SL	slope cable equivalent	f = 40 to 550 MHz	0.2	–	2	dB
FL	flatness of frequency response	f = 40 to 550 MHz	–	–	±0.35	dB
S ₁₁	input return losses	f = 40 to 80 MHz	20	28	–	dB
		f = 80 to 160 MHz	18.5	23	–	dB
		f = 160 to 320 MHz	17	20	–	dB
		f = 320 to 550 MHz	16	20	–	dB
S ₂₂	output return losses	f = 40 to 80 MHz	20	28.5	–	dB
		f = 80 to 160 MHz	18.5	28	–	dB
		f = 160 to 320 MHz	17	24	–	dB
		f = 320 to 550 MHz	16	19	–	dB
S ₂₁	phase response	f = 50 MHz	–45	–	+45	deg
CTB	composite triple beat	77 channels flat; V _o = 44 dBmV; measured at 547.25 MHz	–	–66	–64	dB
X _{mod}	cross modulation	77 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	–	–67	–64	dB
CSO	composite second order distortion	77 channels flat; V _o = 44 dBmV; measured at 548.5 MHz	–	–67	–62	dB
d ₂	second order distortion	note 1	–	–	–72	dB
V _o	output voltage	d _{im} = –60 dB; note 2	66	–	–	dBmV
F	noise figure	see Table 1	–	–	–	dB
I _{tot}	total current consumption (DC)	note 3	–	395	410	mA

Notes

1. $f_p = 55.25$ MHz; $V_p = 44$ dBmV;
 $f_q = 493.25$ MHz; $V_q = 44$ dBmV;
measured at $f_p + f_q = 548.5$ MHz.
2. Measured according to DIN45004B;
 $f_p = 540.25$ MHz; $V_p = V_o$;
 $f_q = 547.25$ MHz; $V_q = V_o - 6$ dB;
 $f_r = 549.25$ MHz; $V_r = V_o - 6$ dB;
measured at $f_p + f_q - f_r = 538.25$ MHz.
3. The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

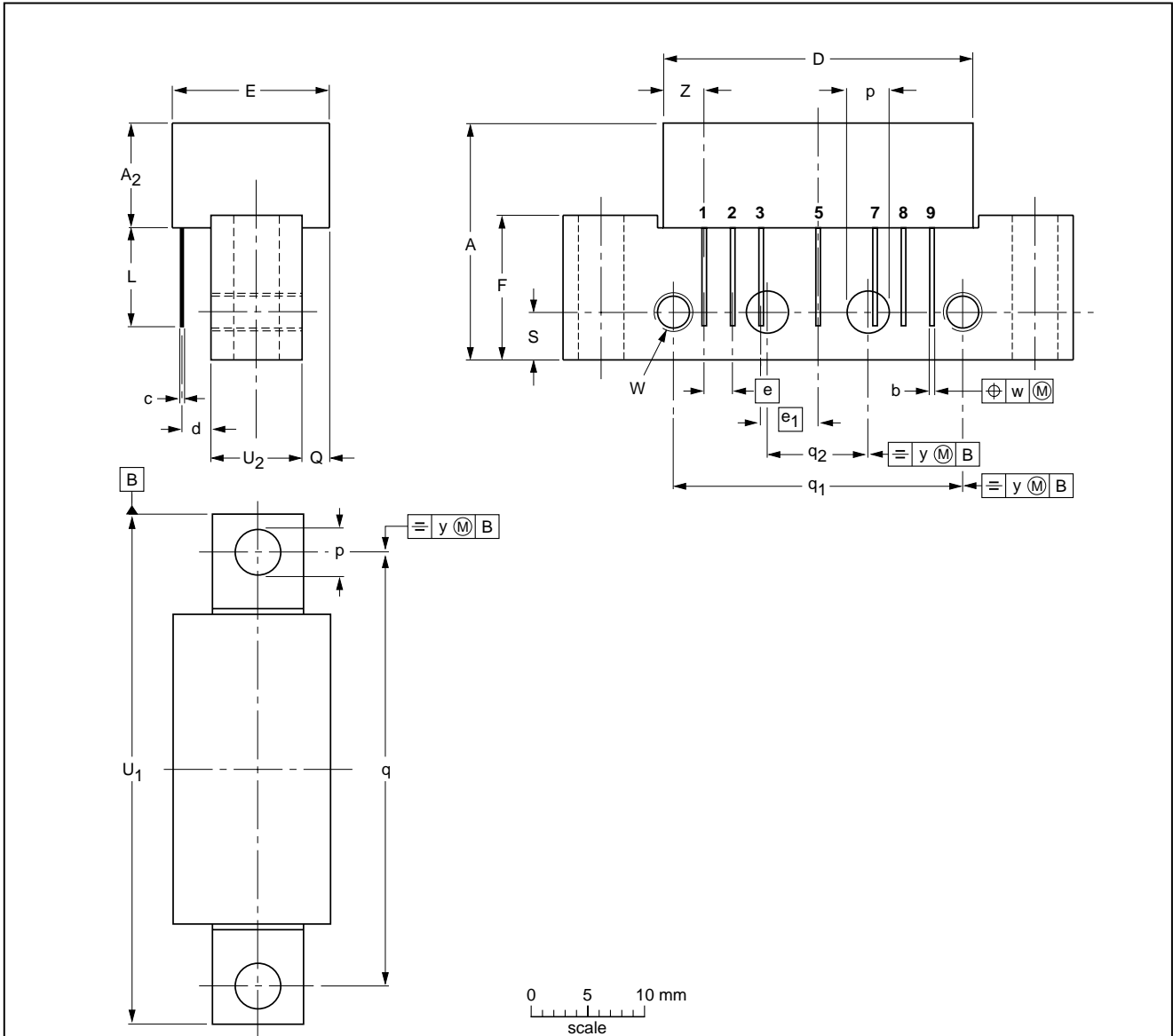
860 MHz, 20 dB gain power doubler amplifier

BGD804

PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₂ max.	b	c	D max.	d max.	E max.	e	e ₁	F	L min.	p	Q max.	q	q ₁	q ₂	S	U ₁ max.	U ₂	W	w	y	Z max.
mm	20.8	9.1	0.51 0.38	0.25	27.2	2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75	8	6-32 UNC	0.25	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT115J						99-02-06

860 MHz, 20 dB gain power doubler amplifier

BGD804

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

1. Please consult the most recently issued data sheet before initiating or completing a design.
2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

DISCLAIMERS

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

860 MHz, 20 dB gain power doubler amplifier

BGD804

NOTES

860 MHz, 20 dB gain power doubler amplifier

BGD804

NOTES

Philips Semiconductors – a worldwide company

Contact information

For additional information please visit <http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

© Koninklijke Philips Electronics N.V. 2001

SCA73

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

613518/03/pp12

Date of release: 2001 Nov 01

Document order number: 9397 750 08855

Let's make things better.

**Philips
Semiconductors**



PHILIPS